

# IRG4PC50UD

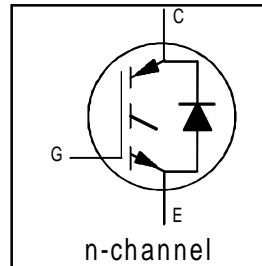
INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE UltraFast CoPack IGBT

## Features

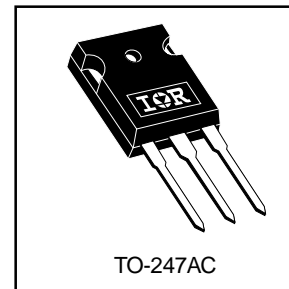
- UltraFast: Optimized for high operating frequencies 8-40 kHz in hard switching, >200 kHz in resonant mode
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- IGBT co-packaged with HEXFRED™ ultrafast, ultra-soft-recovery anti-parallel diodes for use in bridge configurations
- Industry standard TO-247AC package

## Benefits

- Generation 4 IGBT's offer highest efficiencies available
- IGBT's optimized for specific application conditions
- HEXFRED diodes optimized for performance with IGBT's. Minimized recovery characteristics require less/no snubbing
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBT's



$V_{CES} = 600V$   
 $V_{CE(on)} \text{ typ.} = 1.65V$   
 @  $V_{GE} = 15V, I_C = 27A$



## Absolute Maximum Ratings

|                           | Parameter                                        | Max.                              | Units      |
|---------------------------|--------------------------------------------------|-----------------------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Voltage                     | 600                               | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 55                                | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 27                                |            |
| $I_{CM}$                  | Pulsed Collector Current ①                       | 220                               |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②                 | 220                               |            |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current                 | 25                                |            |
| $I_{FM}$                  | Diode Maximum Forward Current                    | 220                               |            |
| $V_{GE}$                  | Gate-to-Emitter Voltage                          | $\pm 20$                          | V          |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 200                               | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 78                                |            |
| $T_J$                     | Operating Junction and Storage Temperature Range | -55 to +150                       | $^\circ C$ |
| $T_{STG}$                 |                                                  |                                   |            |
|                           | Soldering Temperature, for 10 sec.               | 300 (0.063 in. (1.6mm) from case) |            |
|                           | Mounting Torque, 6-32 or M3 Screw.               | 10 lbf•in (1.1 N•m)               |            |

## Thermal Resistance

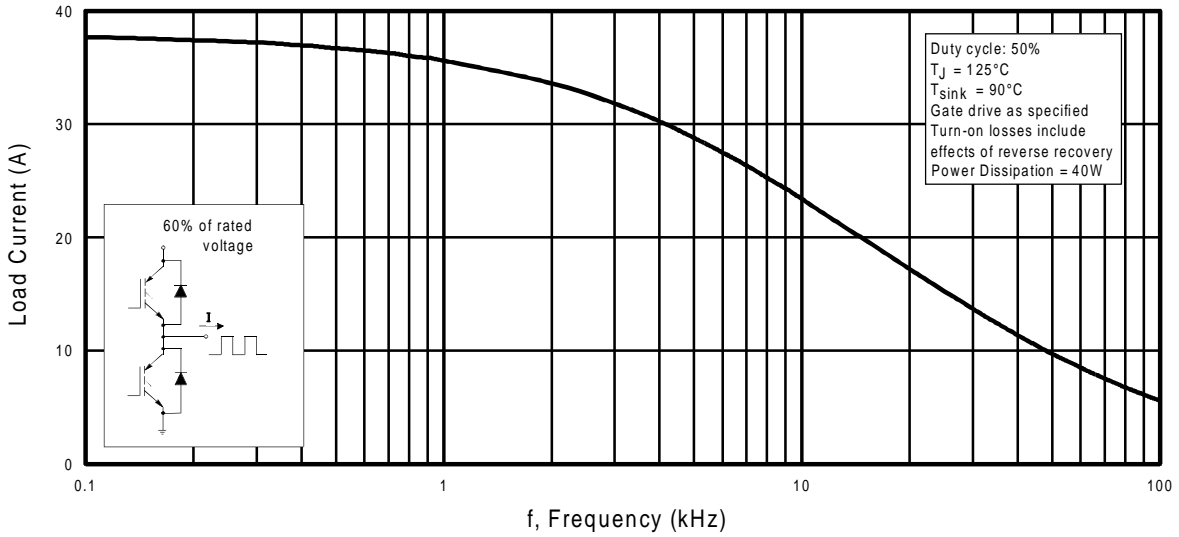
|                 | Parameter                                 | Min.  | Typ.     | Max.  | Units        |
|-----------------|-------------------------------------------|-------|----------|-------|--------------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | ----- | -----    | 0.64  | $^\circ C/W$ |
| $R_{\theta JC}$ | Junction-to-Case - Diode                  | ----- | -----    | 0.83  |              |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface       | ----- | 0.24     | ----- |              |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | ----- | -----    | 40    |              |
| $W_t$           | Weight                                    | ----- | 6 (0.21) | ----- | g (oz)       |

## Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

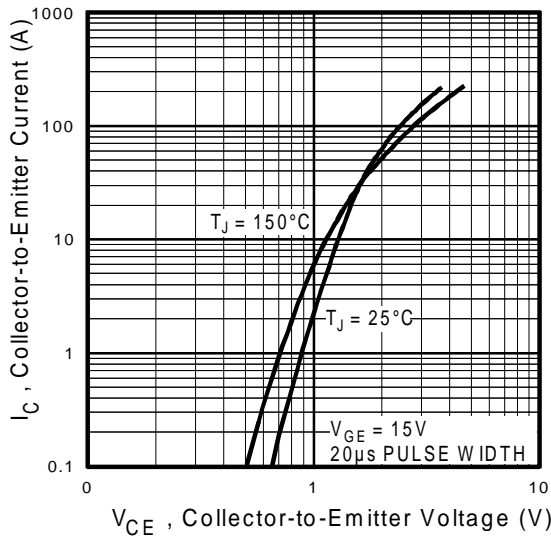
|                                        | Parameter                                           | Min. | Typ. | Max. | Units | Conditions                                                           |
|----------------------------------------|-----------------------------------------------------|------|------|------|-------|----------------------------------------------------------------------|
| V <sub>(BR)CES</sub>                   | Collector-to-Emitter Breakdown Voltage <sup>③</sup> | 600  | ---- | ---- | V     | V <sub>GE</sub> = 0V, I <sub>C</sub> = 250μA                         |
| ΔV <sub>(BR)CES</sub> /ΔT <sub>J</sub> | Temperature Coeff. of Breakdown Voltage             | ---- | 0.60 | ---- | V/°C  | V <sub>GE</sub> = 0V, I <sub>C</sub> = 1.0mA                         |
| V <sub>CE(on)</sub>                    | Collector-to-Emitter Saturation Voltage             | ---- | 1.65 | 2.0  | V     | I <sub>C</sub> = 27A V <sub>GE</sub> = 15V                           |
|                                        |                                                     | ---- | 2.0  | ---- |       | I <sub>C</sub> = 55A See Fig. 2, 5                                   |
|                                        |                                                     | ---- | 1.6  | ---- |       | I <sub>C</sub> = 27A, T <sub>J</sub> = 150°C                         |
| V <sub>GE(th)</sub>                    | Gate Threshold Voltage                              | 3.0  | ---- | 6.0  |       | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA           |
| ΔV <sub>GE(th)</sub> /ΔT <sub>J</sub>  | Temperature Coeff. of Threshold Voltage             | ---- | -13  | ---- | mV/°C | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA           |
| g <sub>fe</sub>                        | Forward Transconductance <sup>④</sup>               | 16   | 24   | ---- | S     | V <sub>CE</sub> = 100V, I <sub>C</sub> = 27A                         |
| I <sub>CES</sub>                       | Zero Gate Voltage Collector Current                 | ---- | ---- | 250  | μA    | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V                         |
|                                        |                                                     | ---- | ---- | 6500 |       | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V, T <sub>J</sub> = 150°C |
| V <sub>FM</sub>                        | Diode Forward Voltage Drop                          | ---- | 1.3  | 1.7  | V     | I <sub>C</sub> = 25A See Fig. 13                                     |
|                                        |                                                     | ---- | 1.2  | 1.5  |       | I <sub>C</sub> = 25A, T <sub>J</sub> = 150°C                         |
| I <sub>GES</sub>                       | Gate-to-Emitter Leakage Current                     | ---- | ---- | ±100 | nA    | V <sub>GE</sub> = ±20V                                               |

## Switching Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

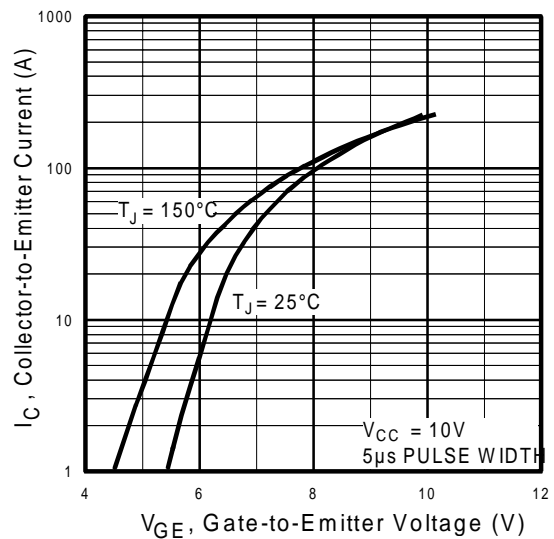
|                          | Parameter                                                 | Min. | Typ. | Max. | Units | Conditions                                               |
|--------------------------|-----------------------------------------------------------|------|------|------|-------|----------------------------------------------------------|
| Q <sub>g</sub>           | Total Gate Charge (turn-on)                               | ---- | 180  | 270  | nC    | I <sub>C</sub> = 27A                                     |
| Q <sub>ge</sub>          | Gate - Emitter Charge (turn-on)                           | ---- | 25   | 38   |       | V <sub>CC</sub> = 400V See Fig. 8                        |
| Q <sub>gc</sub>          | Gate - Collector Charge (turn-on)                         | ---- | 61   | 90   |       | V <sub>GE</sub> = 15V                                    |
| t <sub>d(on)</sub>       | Turn-On Delay Time                                        | ---- | 46   | ---- | ns    | T <sub>J</sub> = 25°C                                    |
| t <sub>r</sub>           | Rise Time                                                 | ---- | 25   | ---- |       | I <sub>C</sub> = 27A, V <sub>CC</sub> = 480V             |
| t <sub>d(off)</sub>      | Turn-Off Delay Time                                       | ---- | 140  | 230  |       | V <sub>GE</sub> = 15V, R <sub>G</sub> = 5.0Ω             |
| t <sub>f</sub>           | Fall Time                                                 | ---- | 74   | 110  |       | Energy losses include "tail" and diode reverse recovery. |
| E <sub>on</sub>          | Turn-On Switching Loss                                    | ---- | 0.99 | ---- | mJ    | See Fig. 9, 10, 11, 18                                   |
| E <sub>off</sub>         | Turn-Off Switching Loss                                   | ---- | 0.59 | ---- |       |                                                          |
| E <sub>ts</sub>          | Total Switching Loss                                      | ---- | 1.58 | 1.9  |       |                                                          |
| t <sub>d(on)</sub>       | Turn-On Delay Time                                        | ---- | 44   | ---- | ns    | T <sub>J</sub> = 150°C, See Fig. 9, 10, 11, 18           |
| t <sub>r</sub>           | Rise Time                                                 | ---- | 27   | ---- |       | I <sub>C</sub> = 27A, V <sub>CC</sub> = 480V             |
| t <sub>d(off)</sub>      | Turn-Off Delay Time                                       | ---- | 240  | ---- |       | V <sub>GE</sub> = 15V, R <sub>G</sub> = 5.0Ω             |
| t <sub>f</sub>           | Fall Time                                                 | ---- | 130  | ---- |       | Energy losses include "tail" and diode reverse recovery. |
| E <sub>ts</sub>          | Total Switching Loss                                      | ---- | 2.3  | ---- | mJ    |                                                          |
| L <sub>E</sub>           | Internal Emitter Inductance                               | ---- | 13   | ---- | nH    | Measured 5mm from package                                |
| C <sub>ies</sub>         | Input Capacitance                                         | ---- | 4000 | ---- | pF    | V <sub>GE</sub> = 0V                                     |
| C <sub>oes</sub>         | Output Capacitance                                        | ---- | 250  | ---- |       | V <sub>CC</sub> = 30V See Fig. 7                         |
| C <sub>res</sub>         | Reverse Transfer Capacitance                              | ---- | 52   | ---- |       | f = 1.0MHz                                               |
| t <sub>rr</sub>          | Diode Reverse Recovery Time                               | ---- | 50   | 75   | ns    | T <sub>J</sub> = 25°C See Fig. 14                        |
|                          |                                                           | ---- | 105  | 160  |       | T <sub>J</sub> = 125°C                                   |
| I <sub>rr</sub>          | Diode Peak Reverse Recovery Current                       | ---- | 4.5  | 10   | A     | T <sub>J</sub> = 25°C See Fig. 15                        |
|                          |                                                           | ---- | 8.0  | 15   |       | T <sub>J</sub> = 125°C                                   |
| Q <sub>rr</sub>          | Diode Reverse Recovery Charge                             | ---- | 112  | 375  | nC    | T <sub>J</sub> = 25°C See Fig. 16                        |
|                          |                                                           | ---- | 420  | 1200 |       | T <sub>J</sub> = 125°C                                   |
| di <sub>(rec)M</sub> /dt | Diode Peak Rate of Fall of Recovery During t <sub>b</sub> | ---- | 250  | ---- | A/μs  | T <sub>J</sub> = 25°C                                    |
|                          |                                                           | ---- | 160  | ---- |       | T <sub>J</sub> = 125°C                                   |



**Fig. 1 - Typical Load Current vs. Frequency**  
 (Load Current =  $I_{RMS}$  of fundamental)

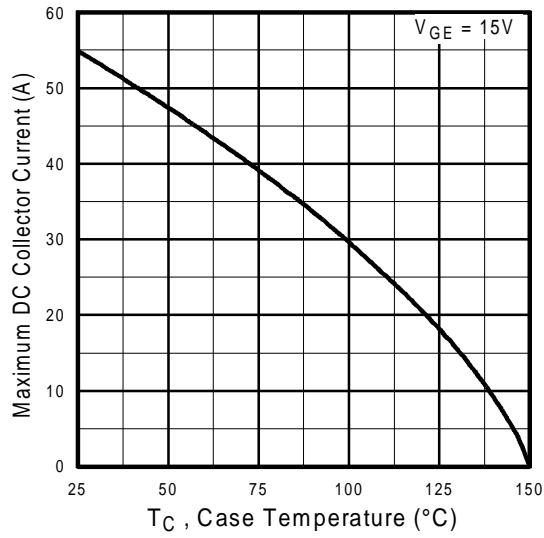


**Fig. 2 - Typical Output Characteristics**

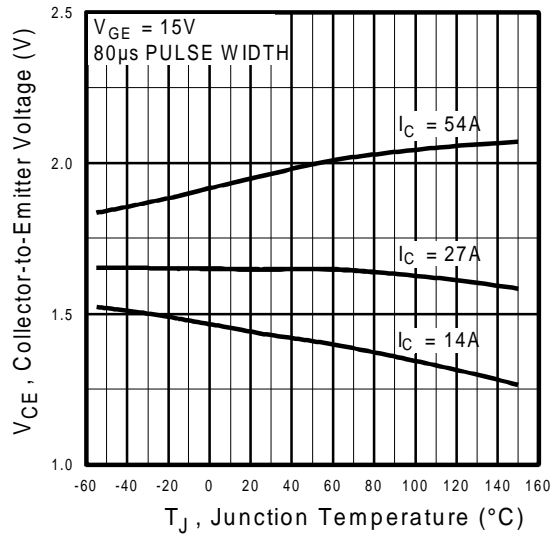


**Fig. 3 - Typical Transfer Characteristics**

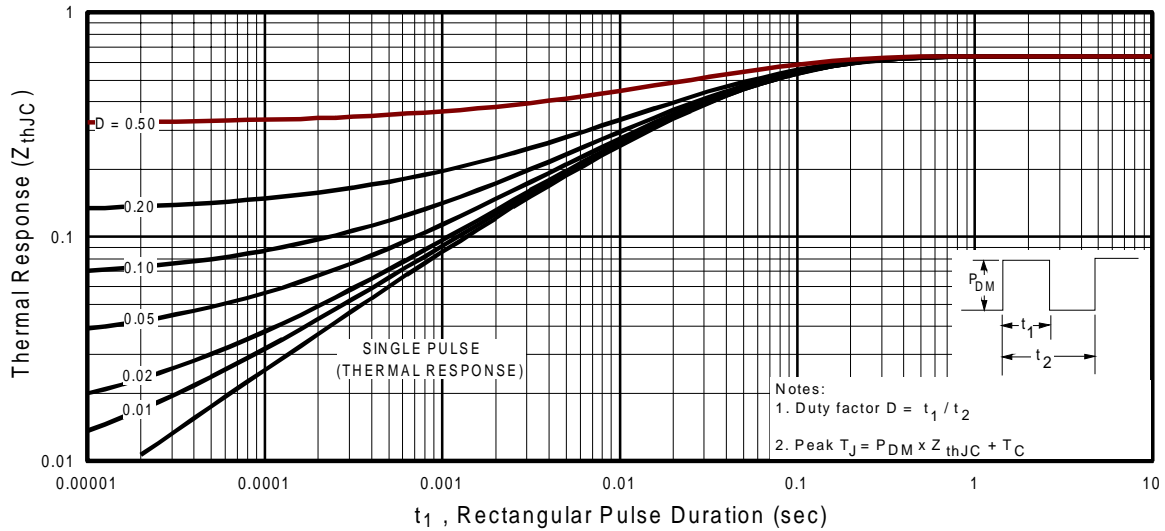
# IRG4PC50UD



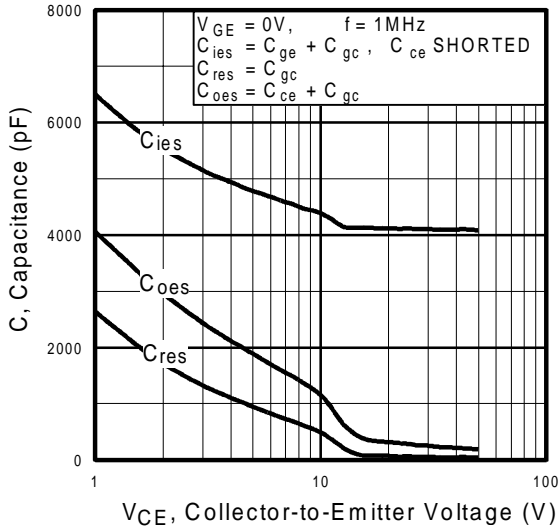
**Fig. 4** - Maximum Collector Current vs. Case Temperature



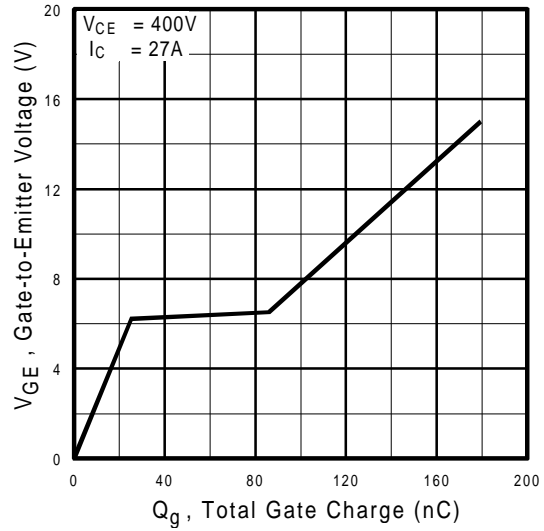
**Fig. 5** - Typical Collector-to-Emitter Voltage vs. Junction Temperature



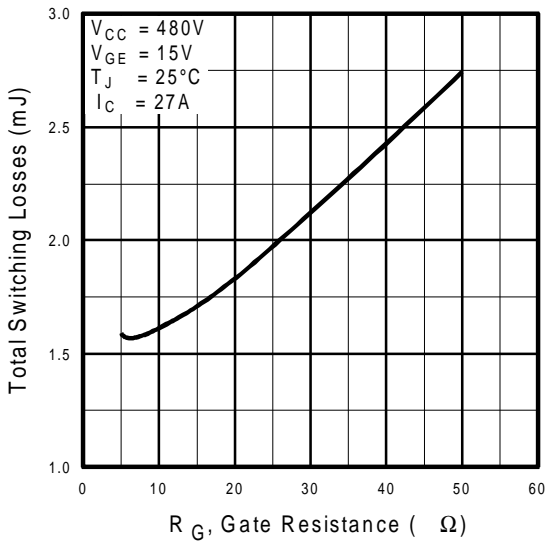
**Fig. 6** - Maximum IGBT Effective Transient Thermal Impedance, Junction-to-Case



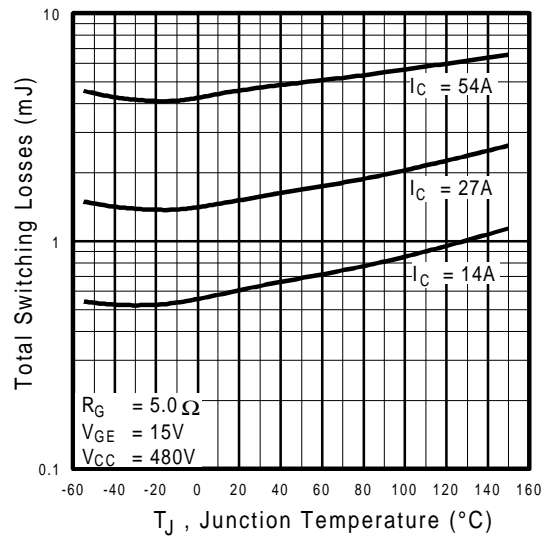
**Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage**

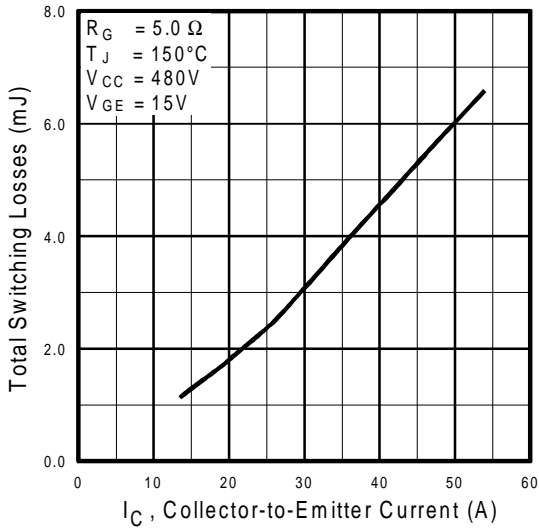


**Fig. 9 - Typical Switching Losses vs. Gate Resistance**

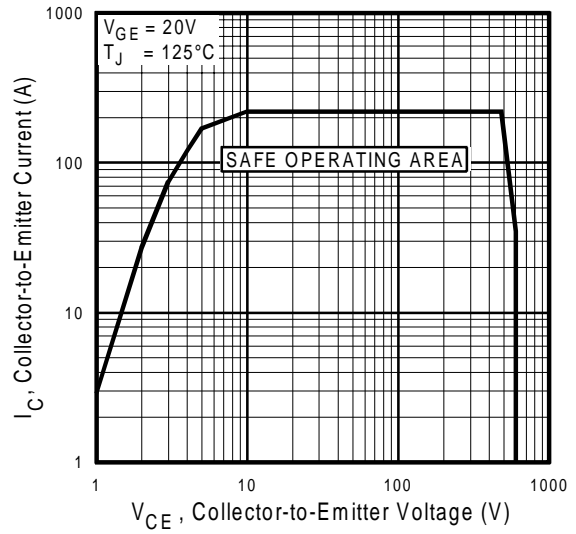


**Fig. 10 - Typical Switching Losses vs. Junction Temperature**

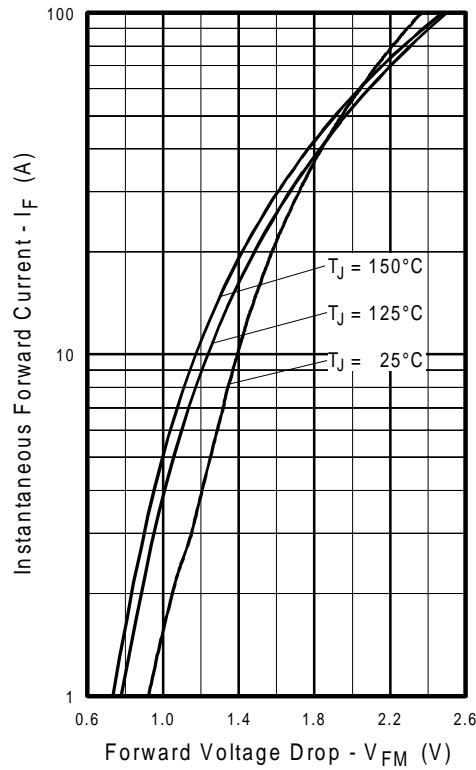
# IRG4PC50UD



**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



**Fig. 12** - Turn-Off SOA



**Fig. 13** - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

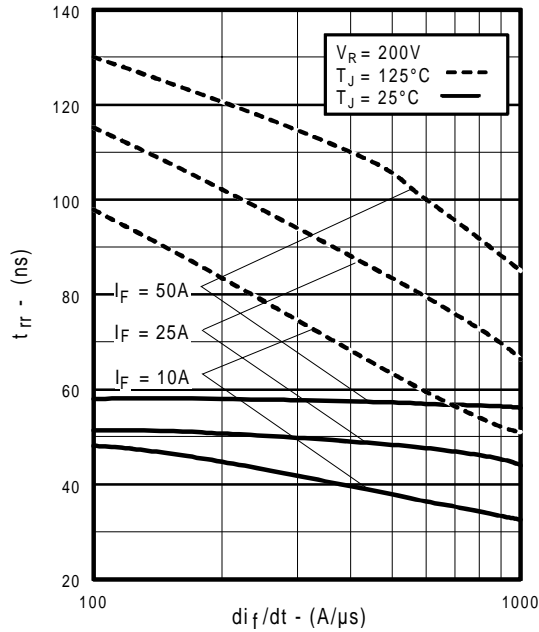


Fig. 14 - Typical Reverse Recovery vs.  $di_f/dt$

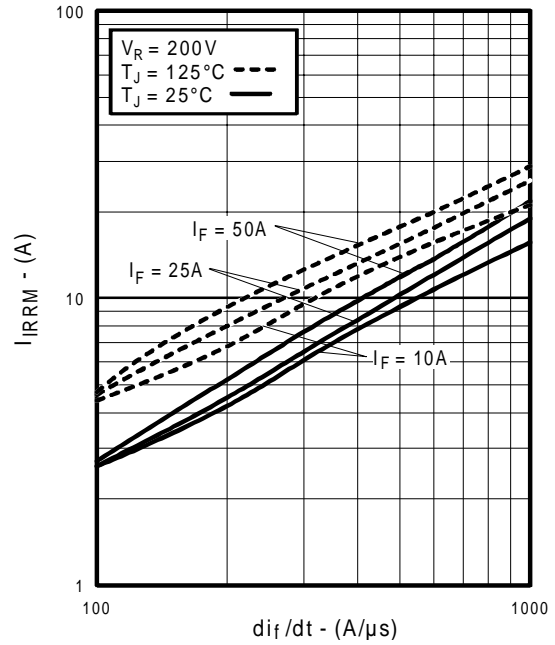


Fig. 15 - Typical Recovery Current vs.  $di_f/dt$

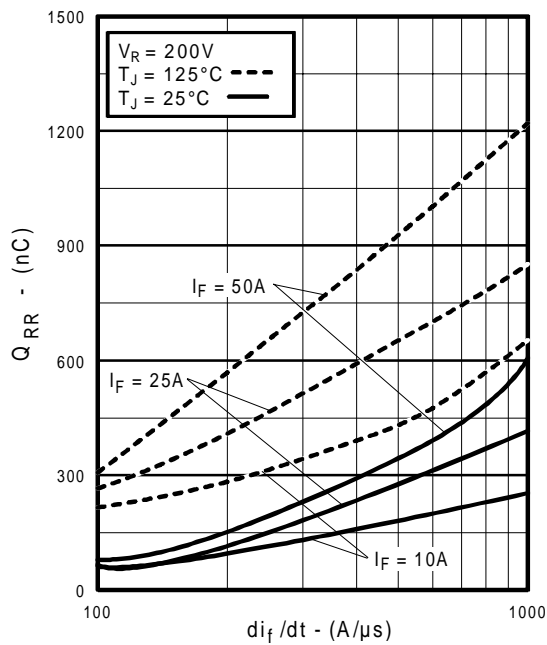


Fig. 16 - Typical Stored Charge vs.  $di_f/dt$

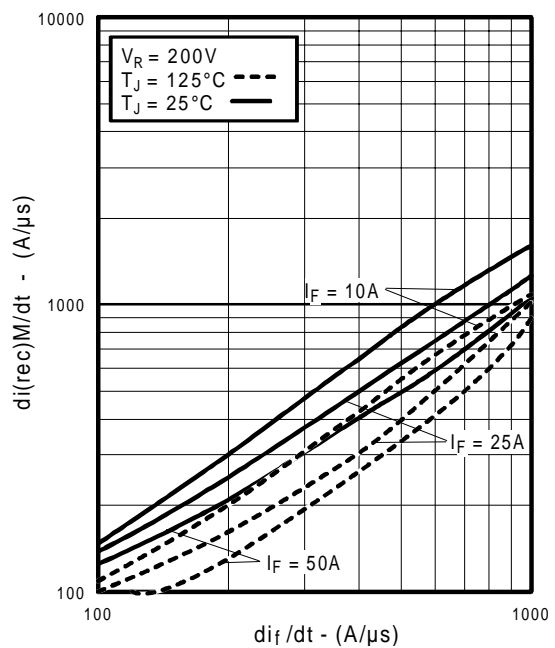
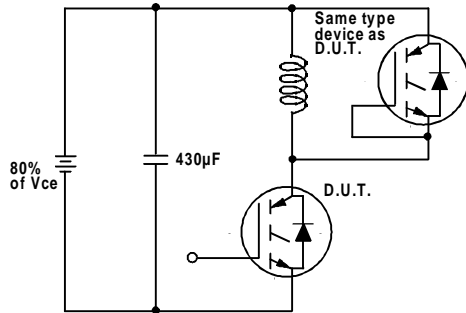
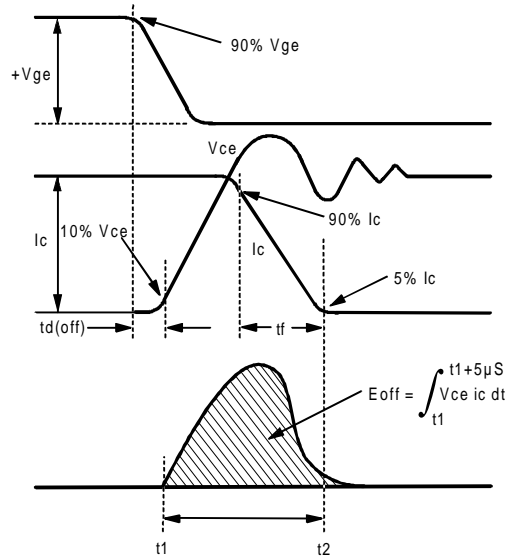


Fig. 17 - Typical  $di_{(rec)M}/dt$  vs.  $di_f/dt$

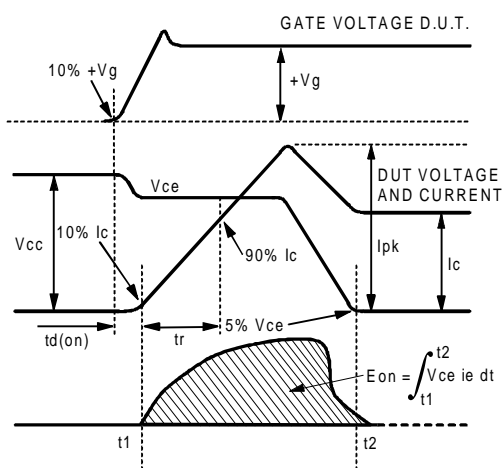
# IRG4PC50UD



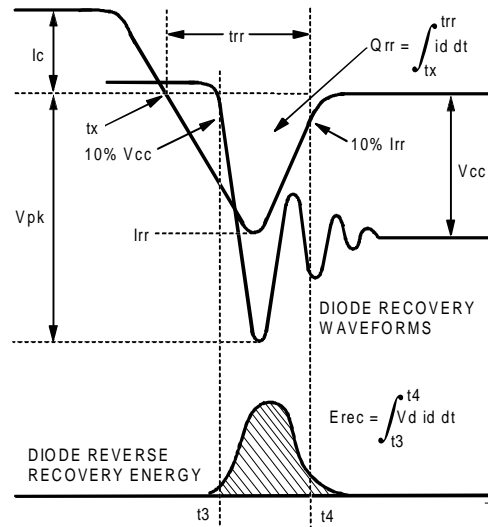
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off}(\text{diode})$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$



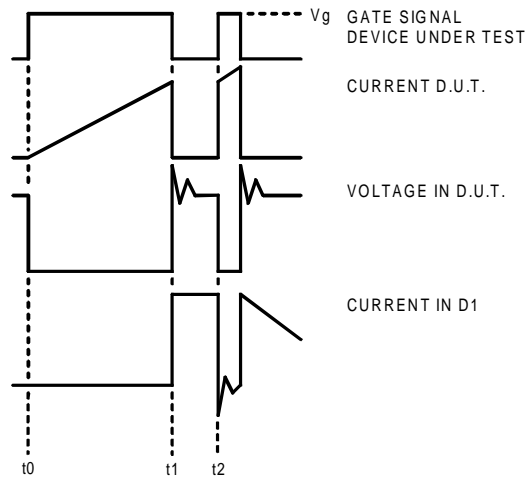


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

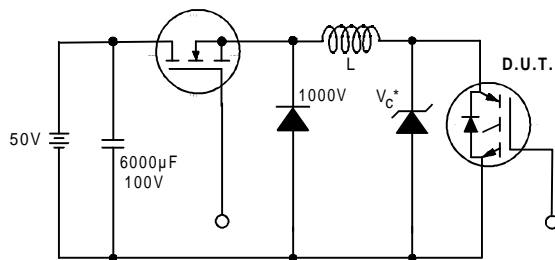


Figure 19. Clamped Inductive Load Test Circuit

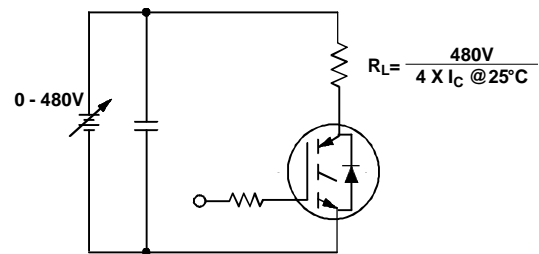


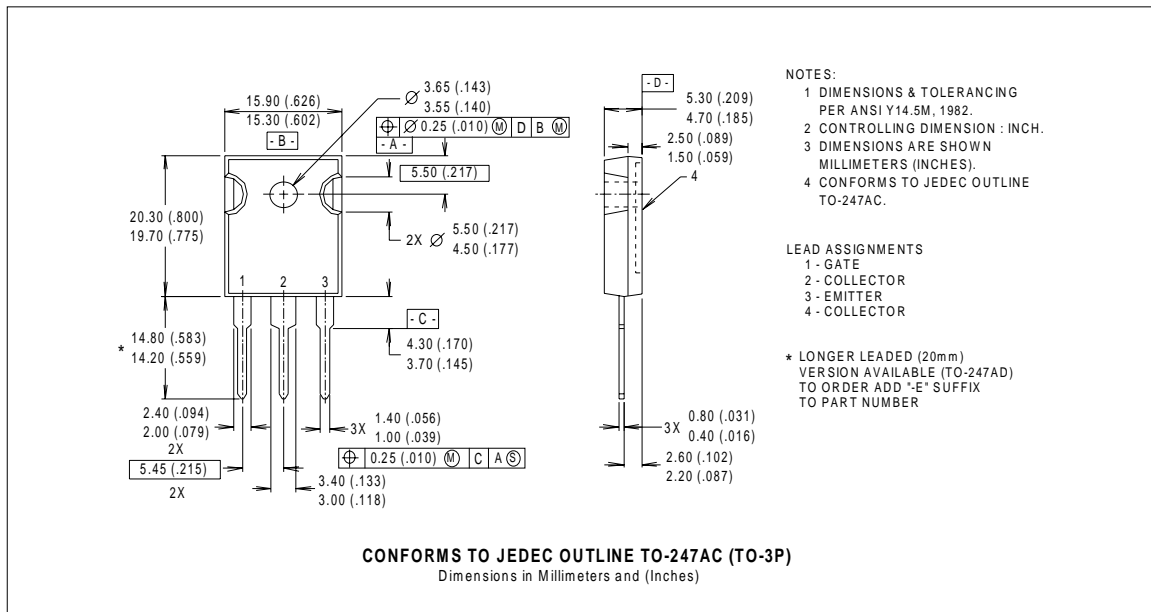
Figure 20. Pulsed Collector Current Test Circuit

# IRG4PC50UD

## Notes:

- ① Repetitive rating:  $V_{GE} = 20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC} = 80\%(V_{CES})$ ,  $V_{GE} = 20V$ ,  $L = 10\mu H$ ,  $R_G = 5.0\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu s$ , single shot.

## Case Outline — TO-247AC



Note: For the most current drawings please refer to the IR website at:  
<http://www.irf.com/package/>